

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	252	(702/99).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/18 16:24
S2	1005	(702/32,33,34).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/18 16:24
S3	667	(on\$1chip\$1 off\$1chip\$1 ) with calibrat\$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:06
S4	7	(temperat\$3 with calibrat\$3) and (virtual\$1 with temperature with point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:00
S5	1	S3 and S4	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 16:59
S6	128	(virtual\$1 with temperature with point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 17:07
S8	1	S3 and S6	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 17:08
S9	29668	temperatur\$3 with calibrat\$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:01
S10	9148	((actual measur\$4) and (offset\$1)) with temperatur\$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:02
S11	85	(semiconductor\$1 with chip\$1) with (temperatur\$3 near (measur\$3 calibrat\$3))	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:03
S12	5	S11 and S3	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:04
S13	1	S4 and S12	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:04
S14	737	(on\$1chip\$1 off\$1chip\$1 ) with (temperatur\$3 with sens \$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:52
S15	1	S14 and S6	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:07

S16	7	S11 and S14	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:54
S17	31907	signal\$1 with generat\$3 with temperatur\$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:55
S18	4630	(signal\$1 with generat\$3 ) same (temperatur\$3 near (actual measur\$3))	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:55
S19	1123	(signal\$1 with generat\$3 ) same (temperatur\$3 near (actual measur\$3)) same (operat\$3 with temperatur\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:57
S20	2	(signal\$1 with generat\$3 ) same (temperatur\$3 near (actual measur\$3)) same (operat\$3 with temperatur\$3) same (calibrat\$3 with temperatur\$3 with (graph\$3 plot \$3 curve\$))	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:56
S21	9	(signal\$1 with generat\$3 ) same (temperatur\$3 near (actual measur\$3)) same (operat\$3 with temperatur\$3) same (signal\$1 with offset\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/18 19:57
S22	41	"20010021217"   "20020087927"   "20030206127"   "20030214998"   "20040008754"   "4644253"   "4713612"   "4779161"   "4964737"   "5046363"   "5154514"   "5171091"   "5213416"   "5414352"   "5477417"   "5488350"   "5502838"   "5519193"   "5590061"   "5617035"   "5639163"   "5764541"   "5829876"   "5902044"   "5920264"   "5942908"   "6002991"   "6005409"   "6008664"   "6344747"   "6363490"   "6425092"   "6491426"   "6559667"   "6701273"   "6724313").PN. OR ("6786639").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 09:43
S24	2647	calibrat\$3 with (temperatur\$3 near sensor\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 09:48
S25	231	(calibrat\$3 with (temperatur\$3 near sensor\$1)) and (calibrat\$3 near point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 09:48
S26	62	(calibrat\$3 with (temperatur\$3 near sensor\$1)) and (calibrat\$3 near point\$1) and (signal\$1 with offset\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 09:49
S27	6	(calibrat\$3 with (temperatur\$3 near sensor\$1)) and (calibrat\$3 near point\$1) and (signal\$1 with offset\$1) and (temperatur\$3 near curve\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:18

S28	47847	(thermomet\$3 temperatur\$3) with ((semiconductor near chip\$1) chip\$1 (integrated near circuit\$1))	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:09
S29	501	S28 and S24	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:09
S30	124	S29 and (actual near temperatur\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:09
S31	24	S29 and (actual near temperatur\$1) and (offset\$1 with signal\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:15
S32	214	(374/172).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/19 10:16
S33	1	S32 and (virtual\$1 with temperatur\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53
S34	14	S32 and S24	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:16
S35	1	S34 and S27	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53
S36	28	("3300710"   "3829717"   "3851241"   "3887863"   "3916508"   "4068134"   "4088941"   "4099115"   "4198676"   "4313083"   "4448549"   "4488824"   "4607962"   "4665356"   "5094546"   "5448158"   "5519354"   "5629612"   "5973528").PN. OR ("6183131").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:20
S37	737	(on\$1chip\$1 off\$1chip\$1 ) with (temperatur\$3 with sens\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:52
S38	737	S37	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:52
S39	0	(on\$1chip\$1 off\$1chip\$1 ) with (temperatur\$3 with calibrat)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53
S40	2160	(on\$1chip\$1 off\$1chip\$1 ) with (temperatur\$3 calibrat\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53
S41	0	S40 and S35	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53

S42	0	S35 and (on\$1chip off\$1chip\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 10:53
S43	5	S31 and ((on\$1chip off\$1chip onchip offchip) with calibrat\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 11:17
S44	5	(mosfet (bipolar with transistor\$1)) with (temperatur\$3 near calibrat\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 11:22
S45	1297	(702/86,104,105,106,107).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/19 11:23
S46	46	S45 and S24	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 11:23
S47	1	S46 and S27	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/19 11:23
S48	1	("20070195858").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/03/26 16:26
S52	2704	(702/32,33,34,99,86,104,105,106,107).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/03/27 15:55
S53	218	(374/172).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/03/27 15:55
S54	682	(on\$1chip with calibrat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2008/03/27 15:56
S55	24	(S52 S53) and S54	US-PGPUB; USPAT; USOCR	OR	ON	2008/03/27 15:57
S56	51	(temperatur\$3 with actual\$1) and ((offset\$1 correct\$3) with signal\$1) and (virtual with point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2008/03/27 15:57
S57	1203	(temperatur\$3 with actual\$1) and ((offset\$1 correct\$3) with signal\$1) and ((virtual calculat\$3 comput\$3) with point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2008/03/27 15:57
S58	1	S57 and S55	US-PGPUB; USPAT; USOCR	OR	ON	2008/03/27 15:58
S59	2834	(702/32,33,34,86,99,104,105,106,107).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/08/11 14:24

S60	218	(374/172).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/08/11 14:25
S61	1326	(onchip offchip on\$1chip off\$1chip) and ((temperatur\$3 thermal) with calibrat\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/11 14:25
S62	47	(S59 S60) and S61	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/11 14:28
S63	3	(virtual\$1 with temperature with point\$1) and (calibrat\$3 with curve\$1) and (offset\$3) and ((thermal temperatur\$3) with calibrat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/11 14:29
S64	0	(S59 S60) and S63	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/11 14:29
S65	3744	(702/32-34,99-107).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 15:50
S66	3612	(702/116-126).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 15:51
S67	4516	(702/182-185).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 15:53

S68	237	(374/172).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 15:53
S69	56861	(thermomet\$3 temperatur\$3) with ((semiconductor near chip\$1) chip\$1 (integrated near circuit\$1))	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:53
S70	38550	(thermost\$3 thermal\$3 temperature thermomet\$3) with calibrat\$4	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:54
S71	1055	(S65 S66 S67 S68) and (S69 S70)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:54
S72	825	(S65 S66 S67 S68) and (S69 S70) and ((signal\$3 with generat\$3) (temperat\$3 with (signal\$3 input\$3)))	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:55
S73	2	(S65 S66 S67 S68) and (S69 S70) and ((signal\$3 with generat\$3) (temperat\$3 with (signal\$3 input\$3))) and (virtual with temperat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:56
S74	2	(S65 S66 S67 S68) and (S69 S70) and ((signal\$3 with generat\$3) (temperat\$3 with (signal\$3 input\$3))) and (virtual with temperat\$4) and (graph\$3 coordinat\$3 point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:56
S75	11	(mosfet (bipolar with transistor\$1)) with (temperatur\$3 near calibrat\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:57
S76	2	(S65 S66 S67 S68 S69) and S75	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:57
S77	3	(virtual\$1 with temperature with point\$1) and (calibrat\$3 with curve\$1) and (offset\$3) and ((thermal temperatur\$3) with calibrat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:57
S78	0	S76 and S77	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:57
S79	1479	(temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:58

S80	263	((temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4) ) and ((measur\$4 and actual\$3) with value\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:59
S81	44	((temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4) ) and ((measur\$4 and actual\$3) with value\$1) and ((graph\$3 curve\$1) with analy\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 15:59
S82	0	((temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4) ) and ((measur\$4 and actual\$3) with value\$1) and ((graph\$3 curve\$1) with analy\$4) and ((virtual with actual\$3) with point\$1)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 16:00
S84	0	((((temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4) ) and ((measur\$4 and actual\$3) with value\$1) and ((graph\$3 curve\$1) with analy\$4) and ((virtual with actual\$3) with point\$1) ) and (S65 S66 S67 S68 S69)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 16:00
S85	0	((((temperat\$4 thermomet\$3 therm\$4) with (extract\$3 and calibrat\$4) ) and ((measur\$4 and actual\$3) with value\$1) and ((graph\$3 curve\$1) with analy\$4) and ((virtual with actual\$3) with point\$1) ).clm.	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 16:00
S86	9484	((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:01
S87	1421	((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4) and (signal\$3 with input\$3 with (temperat\$3 thermomet\$3 thermal\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:03

S88	2	(((((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4) and (signal\$3 with input\$3 with (temperat\$3 thermomet\$3 thermal\$3)) and (different\$3 with point\$3) and ((graph\$3 coordinat\$3 visual\$3) with analy\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:03
S89	2	(((((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4) and (signal\$3 with input\$3 with (temperat\$3 thermomet\$3 thermal\$3)) and (different\$3 with point\$3) and ((graph\$3 coordinat\$3 visual\$3 histogram\$3) with analy\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:04
S90	56861	(thermomet\$3 temperatur\$3) with ((semiconductor near chip\$1) chip\$1 (integrated near circuit\$1))	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 16:04
S91	0	(((((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4) and (signal\$3 with input\$3 with (temperat\$3 thermomet\$3 thermal\$3)) and (different\$3 with point\$3) and ((graph\$3 coordinat\$3 visual\$3 histogram\$3) with analy\$4) and (calibrat\$4 with (graph\$3 curv\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:05
S92	3	(virtual\$1 with temperature with point\$1) and (calibrat\$3 with curve\$1) and (offset\$3) and ((thermal temperatur\$3) with calibrat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2009/04/10 16:05
S93	0	(((((semiconductor\$1 circuit) with temperatur\$3) same calibrat\$4) and (signal\$3 with input\$3 with (temperat\$3 thermomet\$3 thermal\$3)) and (different\$3 with point\$3) and ((graph\$3 coordinat\$3 visual\$3 histogram\$3) with analy\$4) and (calibrat\$4 with (graph\$3 curv\$3))).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:05
S94	6128	(324/765).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 16:06



S95	0	S92 and S94	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:06
S96	7084	calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:07
S97	915	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 most\$4) with (thermal\$3 temperat\$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:08
S98	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 most\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:09
S99	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 most\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4) ) and S65 S66 S67 S68 S94)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:17

S100	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 mos\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4) ).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:18
S101	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 mos\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4) and ((on\$1 chip off\$1 chip) with calibrat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:35
S102	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 mos\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4) and ((on\$1 chip off\$1 chip) with calibrat\$4) and (S65 S66 S67 S68 S94)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:36
S103	0	((calibrat\$3 with (circuit\$1 (semiconductor with chip\$1)) same (temperat\$3 thermomet\$3) ) and ((bipolar\$3 transistor\$3 mos\$4) with (thermal\$3 temperat\$4)) and (virtual with temperatur\$3 with point\$1) and ((curv\$3 graph\$3) with analy\$4) and ((on\$1 chip off\$1 chip) with calibrat\$4)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:36
S104	0	S103 and (S65 S66 S67 S68 S94)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:36

S105	1930	(327/141).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 16:39
S106	659	(714/744,814).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 16:39
S107	0	S98 and (S105 S106)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:40
S108	1811	(702/130-136).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 16:41
S110	0	S93 and S108	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:41

S111	0	S103 and S108	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:42
S112	188	(702/86).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/04/10 16:44
S113	0	S102 and S112	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/04/10 16:44

4/10/2009 4:53:35 PM

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